NCH75R130PT

N-Channel Silicon Carbide MOSFET

Pb-Free RoHS COMPLIANT

Voltage:	750	Volts	Current:	19.5	Amperes	Package:	TO-247

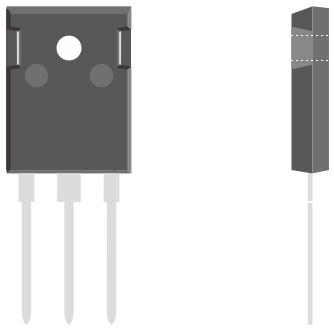
Features

- NH'S Advanced Silicon Carbide MOSFET Technology
- High Blocking Voltage And Low Capacitances
- High-Speed Switching For Very Low Switching Losses
- Excellent Qg*Rds(on) Product(FOM）

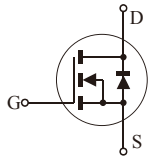
Typical Applications

- High Voltage DC/DC Converters
- Adaptor And Charger
- Battery Chargers And Motor Drives
- LED Drives And LED Lighting

Diagram:



Polarity:



Product Summary

VDS Min.@T_j	750	**V**
I_D Min.@Ta	19.5	**A**
RDS(ON)(TYP)@18V,Tj=25℃	130	**mΩ**

***100% UIS TESTED**

***100% ΔVDS TESTED**

Absolute Maximum Ratings (Ta=25℃ Unless Otherwise Specified)

Parameter	Test Conditions	Symbol	Ratings	Unit
Drain-Source Voltage		V_{DS}	750	V
Gate-Source Voltage		$V_{GS\ MAX.}$	-10/+22	V
		$V_{GS\ O.P.}$	0/+18	
Continuous Drain Current (Note 1)	Ta= 25 ℃	I_D	19.5	A
	Ta= 100 ℃		15.6	
Drain Current-Pulse (Note 1)	T_J< 175 ℃	I_{DM}	35.1	A
Maximum Power Dissipation Power	Ta= 25 ℃	P_D	254	W
Dissipation Derating Factor Above 25℃	Ta= 100 ℃		127	
Derating Factor		D_F	1.69	W/℃
Avalanche Current,Single Pulse (Note 1)	L= 0.5 mH	I_{AS}	11.6	A
Single Pulse Avalanche Energy (Note 1) Test Circuit & Waveform See Fig.22	L= 0.5 mH IAS= 11.6 A,RG= 10.0 Ω Starting Tj=25 ℃,VG = 18.0 V	E_{AS}	34	mJ

Thermal Characteristcs (Ta=25℃ Unless Otherwise Specified)

Parameter	Test Conditions	Symbol	Typ.	Unit
Junction Temperature		T_J	-55 to 175	℃
Storage Temperature Range		T_{STD}	-55 to 175	℃
Thermal Resistance Junction To Ambient With Steady-State	Still Air Environment With Ta=25℃	$R_{\theta JA}$	50	℃/W
Thermal Resistance Junction-Case With Steady-State	Device Mounted On 75mm x 45mm x 2.5mm Alu. Heat.	$R_{\theta JC}$	0.59	

Notes: 1.Pulse Width Limited By Max. Junction Temperature. (See Fig. 19).

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Electrical Characteristcs (Ta=25℃ Unless Otherwise Specified)

Parameter	Test Conditions		Symbol	Min.	Typ.	Max.	Unit
Static Off Characteristics							
Drain-Source Breakdown Voltage	VGS=0V,ID=100uA		BV_{DSS}	750	--	--	V
Zero Gate Voltage Drain Current	VDS= 750 V,VGS=0V,Tj=25℃		I_{DSS}	--	0.1	20	uA
	VDS= 750 V,VGS=0V,Tj=175℃			--	5	--	
Gate To Source Leakage Current	VGS= 22 V,VDS=0V		I_{GSS}	--	--	250	nA
Source To Gate Leakage Current	VGS= -10 V,VDS=0V		I_{SGS}	--	--	250	nA
Forward Transconductance	ID= 11.3 A,VDS= 20 V		gfs	--	4.3	--	S
Static On Characteristics							
Gate Threshold Voltage	VGS= VDS, ID=10mA ,Tj=25℃		$V_{GS(TH)}$	3	3.8	5	V
	VGS= VDS, ID=10mA ,Tj=175℃			--	2.7	--	
Drain-Source On Resistance	ID= 11.3 A,VGS= 18.0 V,Tj=25℃		$R_{DS(ON)}$	--	130	160	mΩ
	ID= 11.3 A,VGS= 18.0 V,Tj=175℃			--	146	179	
	ID= 11.3 A,VGS= 15.0 V,Tj=25℃			--	169	240	
	ID= 11.3 A,VGS= 15.0 V,Tj=175℃			--	154	218	
Dynamic Characteristics							
Gate Resistance	VGS=0V,VDS=0V,Freq.=1MHz		R_g	--	31	--	Ω
Input Capacitance	VDS= 650 V		C_{iss}	--	415	--	pF
Output Capacitance	VGS= 0 V		C_{oss}	--	30	--	pF
Reverse Transfer Capacitance	F= 1 MHZ		C_{rss}	--	4.5	--	pF
Switching Paramters (Test Circuit & Waveform See Fig.20)							
Turn-On Delay Time	VDS= 400 V	Tj=25℃	$t_{d(on)}$	--	29	--	ns
	ID= 11.3 A	Tj=175℃		--	27.6	--	
Turn-On Rise Time	VGS= 0/+18 V	Tj=25℃	t_r	--	11.5	--	ns
	RG= 10.0 Ω	Tj=175℃		--	9.0	--	
Turn-Off Delay Time	L= 600 μH	Tj=25℃	$t_{d(off)}$	--	46	--	ns
		Tj=175℃		--	43.7	--	
Turn-Off Rise Time		Tj=25℃	t_f	--	16.5	--	ns
		Tj=175℃		--	14.0	--	
Turn−On Switching Loss		Tj=25℃	E_{on}	--	67.6	--	μJ
		Tj=175℃		--	52.7	--	
Turn−Off Switching Loss		Tj=25℃	E_{off}	--	14.9	--	μJ
		Tj=175℃		--	12.7	--	
Total Switiching Energy		Tj=25℃	E_{tot}	--	82.5	--	μJ
		Tj=175℃		--	65.4	--	

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Electrical Characteristcs (Ta=25℃ Unless Otherwise Specified)

Parameter	Test Conditions		Symbol	Min.	Typ.	Max.	Unit
Gate Charge Paramters (Test Circuit & Waveform See Fig.21)							
Total Gate Charge	VDS= 400 V		Q_g	--	15	--	nC
Gate-Source Charge	VGS= 0/+18 V		Q_{gs}	--	5.5	--	nC
Gate-Drain Charge	ID= 11.3 A		Q_{gd}	--	2.5	--	nC
Drain-Source Diode Characteristics And Maximum Ratings (Test Circuit & Waveform See Fig.23)							
Max. Diode Forward Current	Tj= 25 ℃		I_S	--	--	19.5	A
tp Limited by T_J(max)	Tj= 100 ℃			--	--	15.6	
Max. Pulsed Forward Current			I_{SM}	--	--	39.0	A
Diode Forward Voltage	ID= 3.5 A,VGS=-0V	Tj=25℃	V_{SD}	--	3.3	--	V
		Tj=175℃		--	2.8	--	
Reverse Recovery Time	IS= 11.3 A di/dt= 1000 A/us	Tj=25℃	t_{rr}	--	26	--	ns
		Tj=175℃		--	29.4	--	
Reverse Recovery Charge	VGS= 0.0 V VDS= 400 V	Tj=25℃	Q_{rr}	--	68	--	nC
		Tj=175℃		--	78.2	--	
Reverse Recovery Current		Tj=25℃	I_{rrm}	--	6.9	--	A
		Tj=175℃		--	5.3	--	
Reverse Recovery Energy		Tj=25℃	E_{rr}	--	5.0	--	µJ
		Tj=175℃		--	7.2	--	

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Typical Characteristics Curves

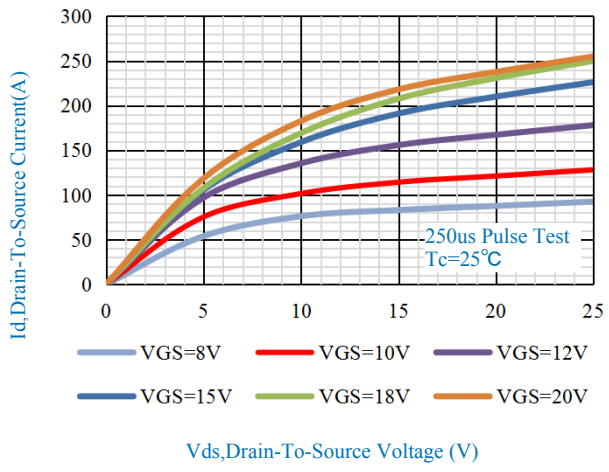


Fig.1-Output Characteristic@Tj=25℃

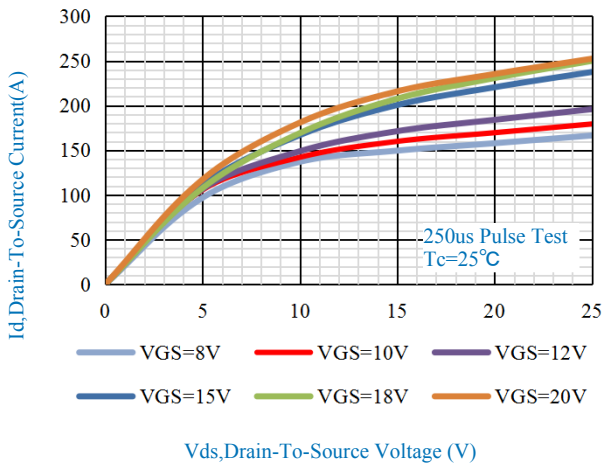


Fig.2-Output Characteristic@Tj=175℃

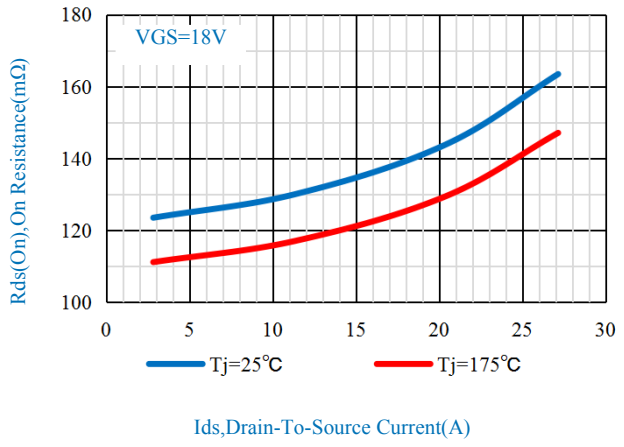


Fig.3-On Resistance Vs. Drain Current

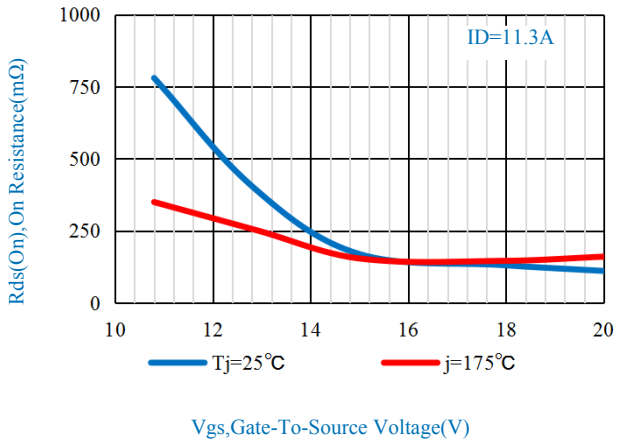


Fig.4-On Resistance Vs. Gate Source Voltage

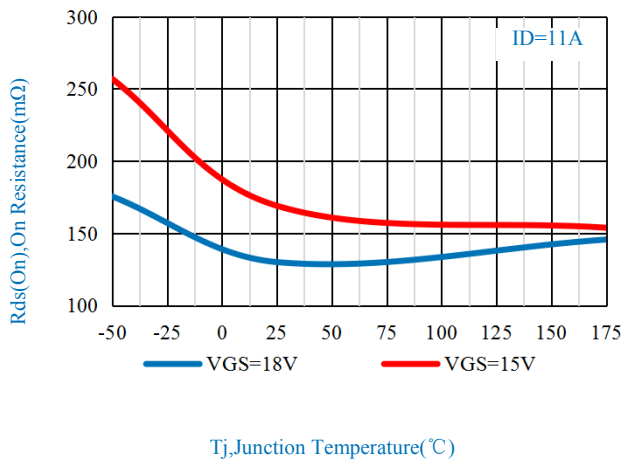


Fig.5-On Resistance Vs. Junction Temperature

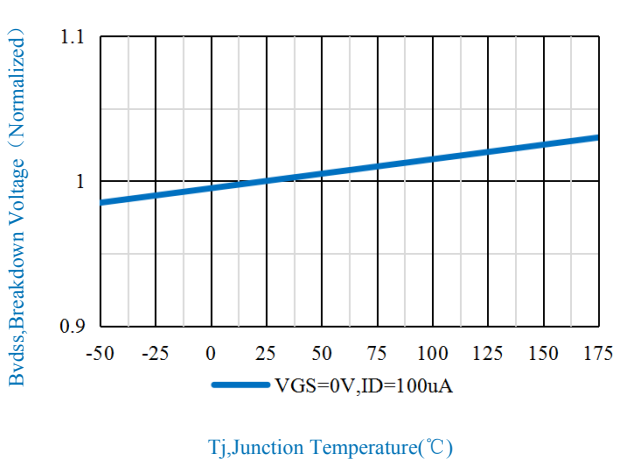


Fig.6-Breakdown Voltage Vs. Junction Temperature

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Typical Characteristics Curves

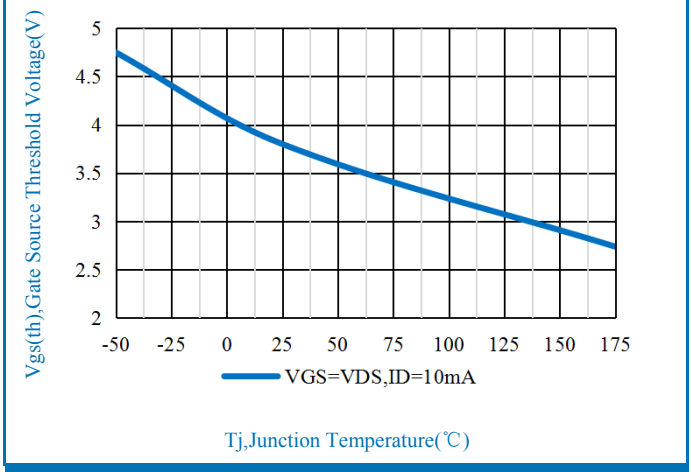


Fig.7-Gate Source Threshold Voltage Vs. Junction Temperature

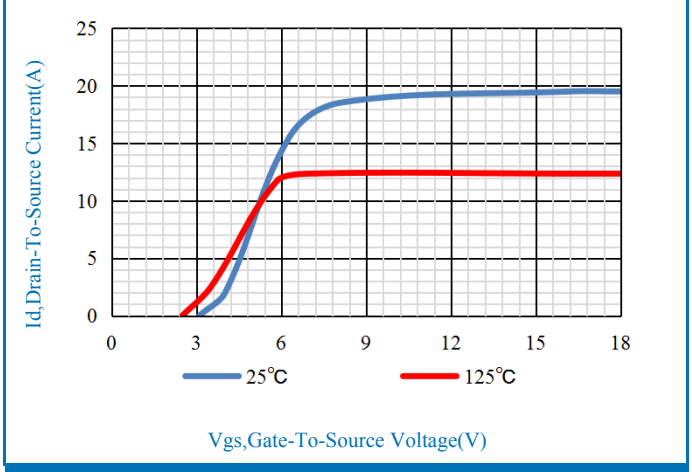


Fig.8-Transfer Characteristic

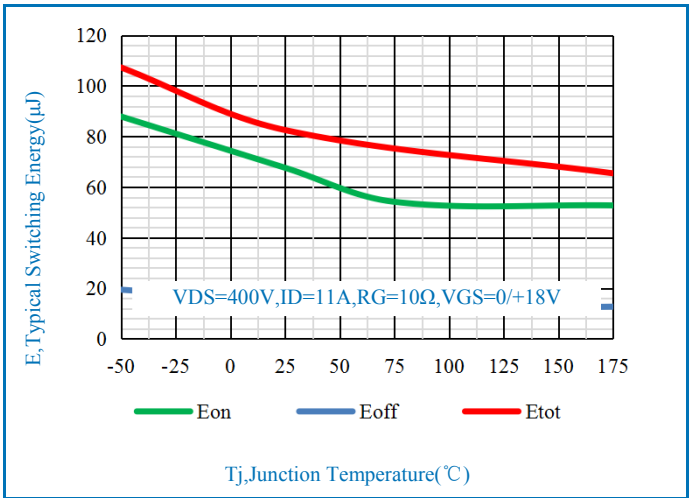


Fig.9-Typical Switching Energy Vs. Junction Temperature

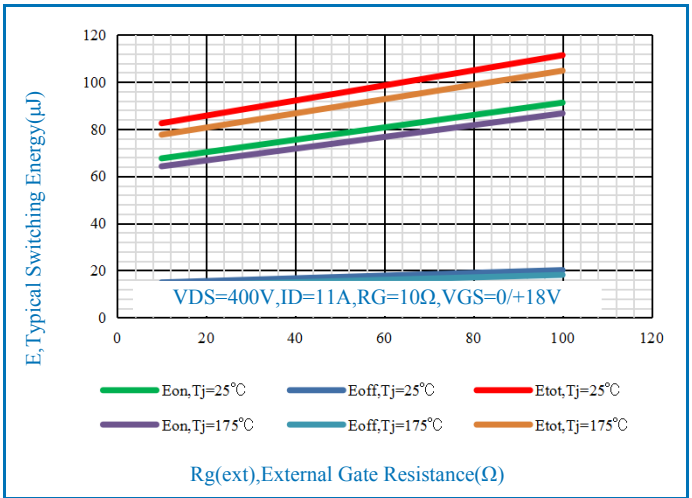


Fig.10-Typical Switching Energy Vs. External Gate Resistance

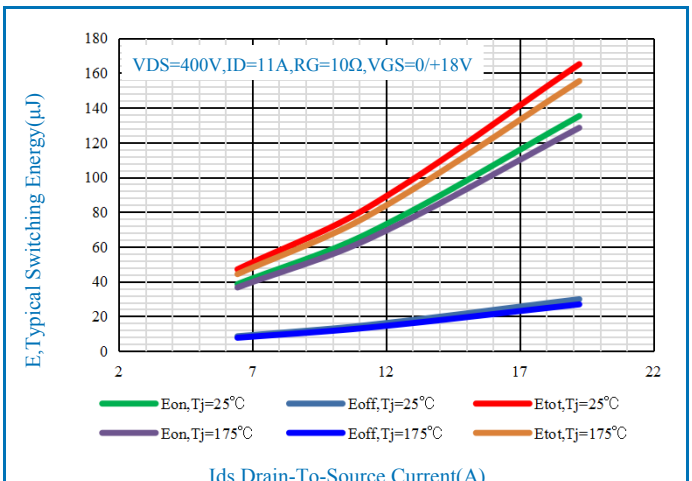


Fig.11-Typical Switching Energy Vs. Drain Source Current

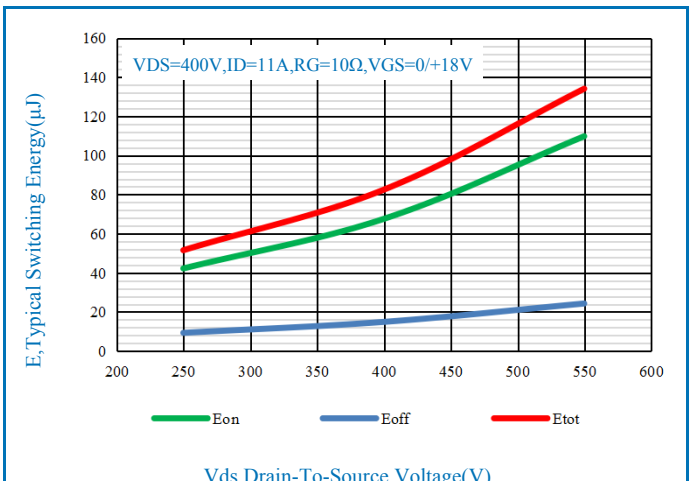


Fig.12-Typical Switching Energy Vs. Drain Source Voltage

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Typical Characteristics Curves

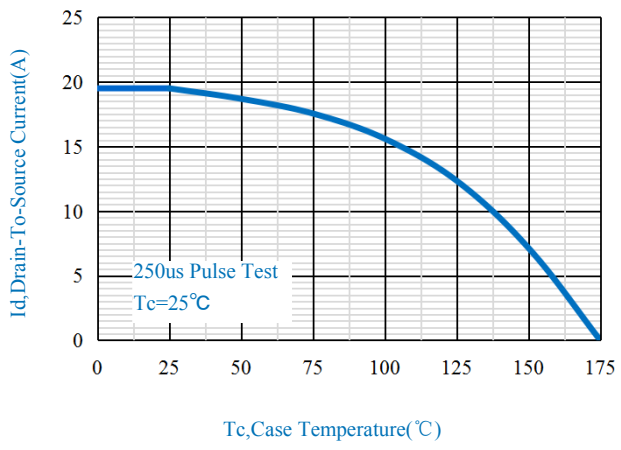


Fig.13-Maximum Continuous Drain Current Vs. Case Temperature

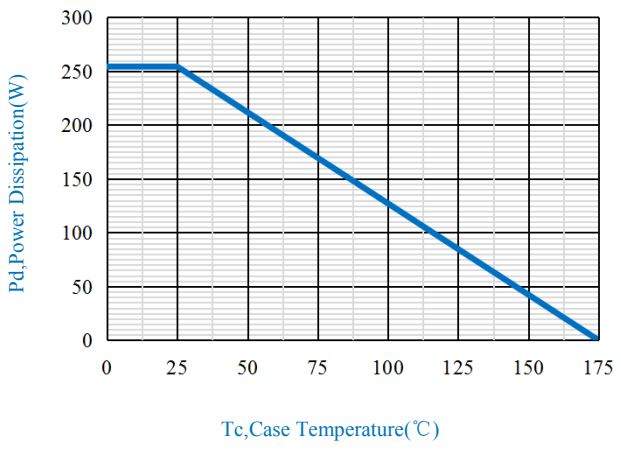


Fig.14-Maximum Power Dissipation Vs. Case Temperature

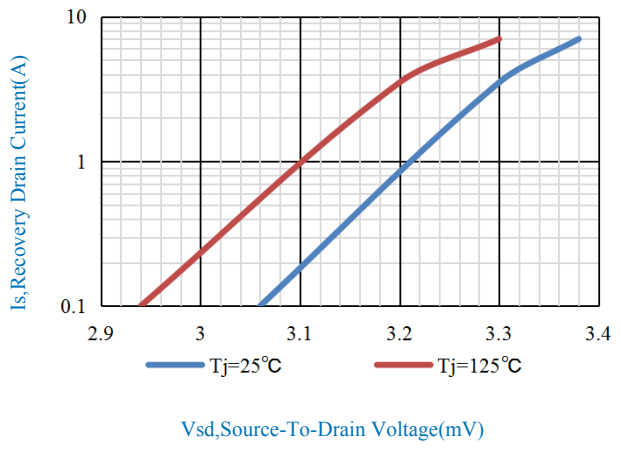


Fig.15-Source-To-Drain Diode Forward Voltage

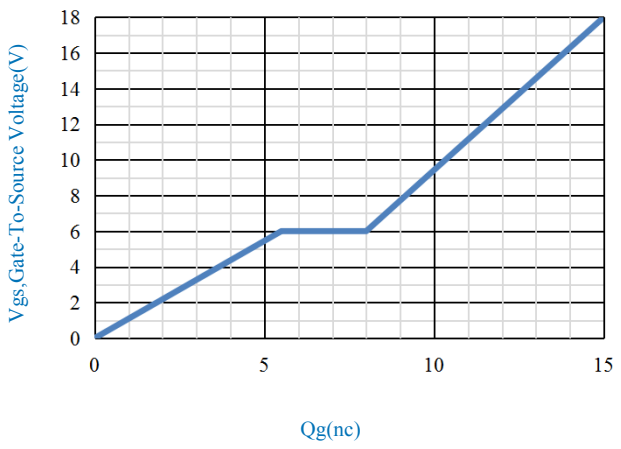


Fig.16-Gate Charge Waveform

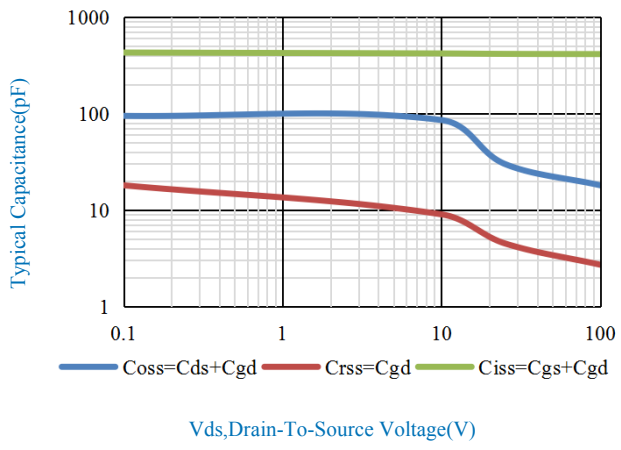


Fig.17-Typical Capacitance Vs. Drain-To-Source Voltage

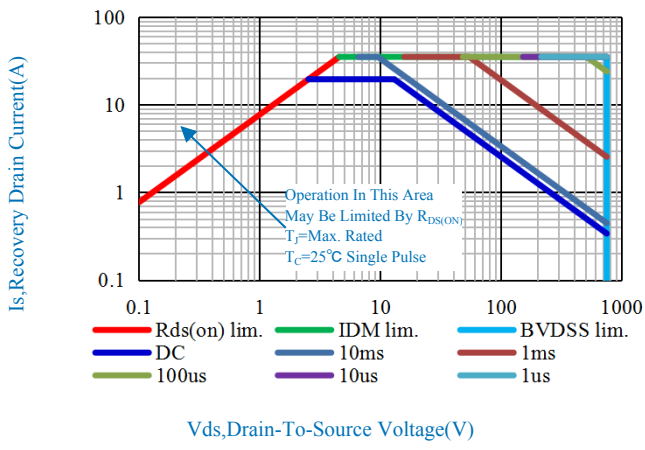


Fig.18-Maximum Safe Operating Area(SOA)

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Typical Characteristics Curves

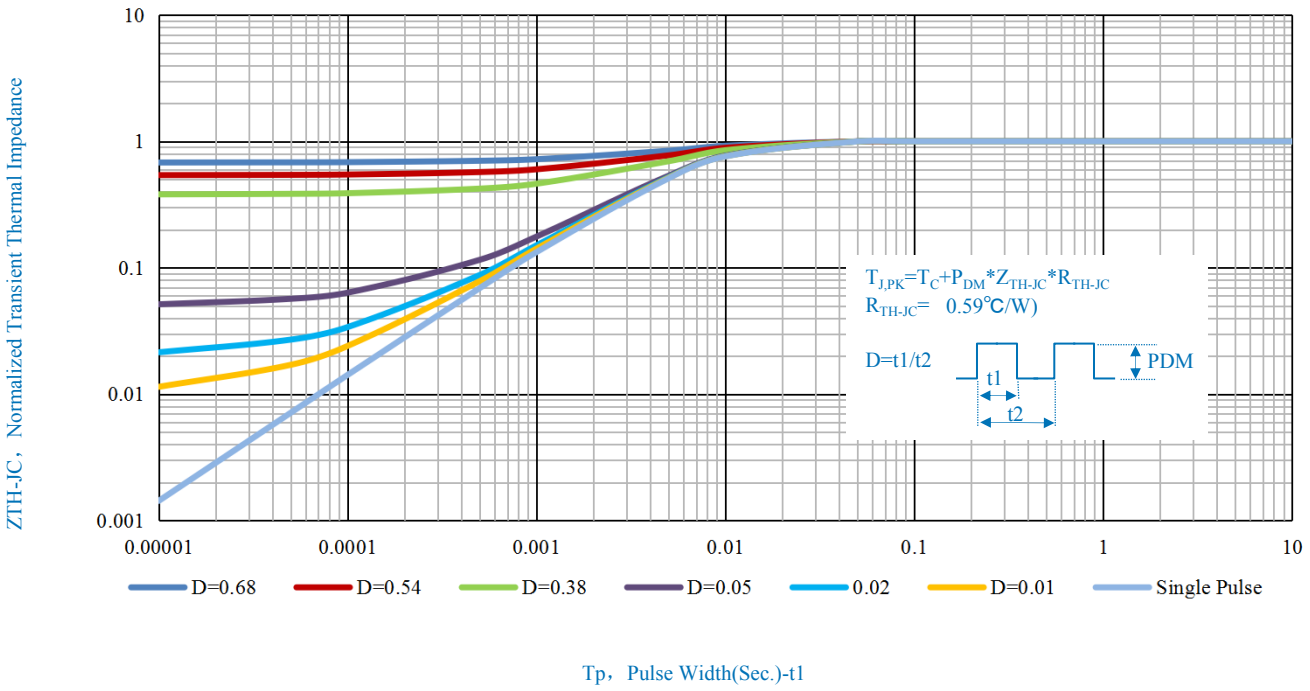


Fig.19- Normalized Maximum Transient Thermal Impedance Vs.Pulse Width

Test Circuit & Waveform

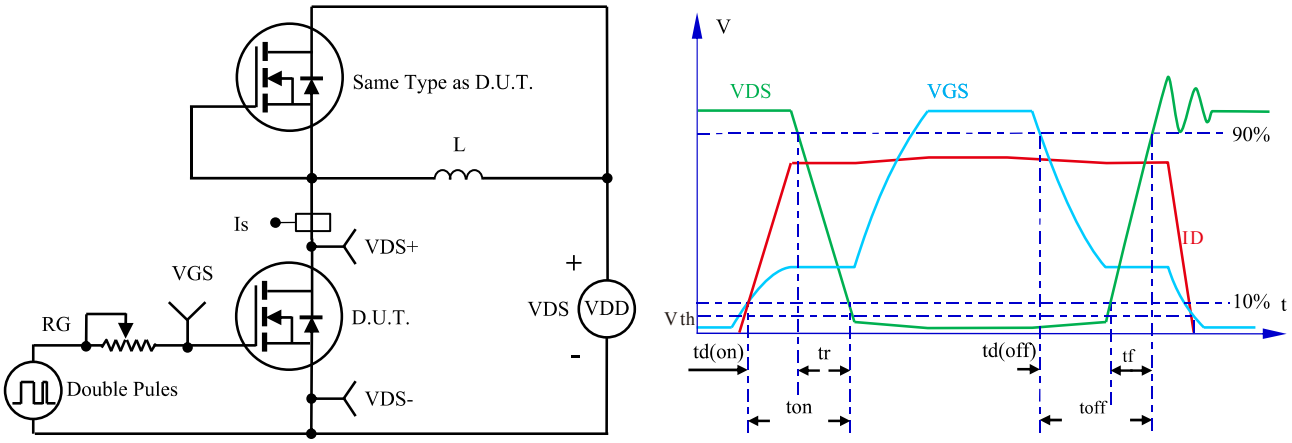


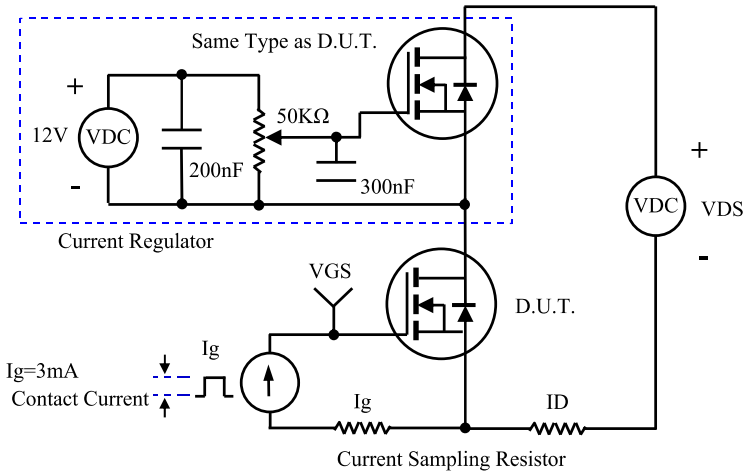
Fig.20- Inductive Switching Test Circuit & Waveform

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Test Circuit & Waveform



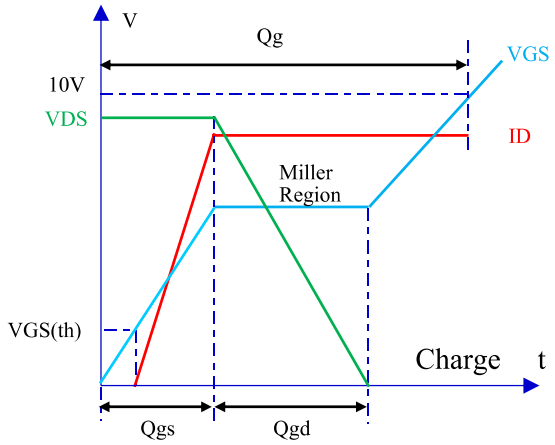
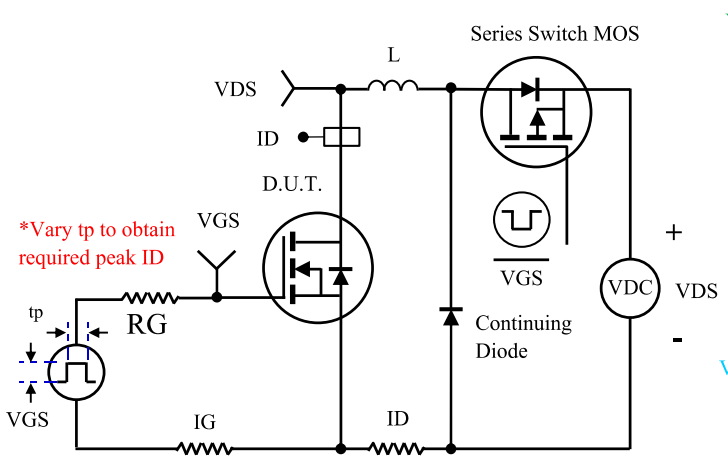


Fig.21-Gate Charge Test Circuit & Waveform



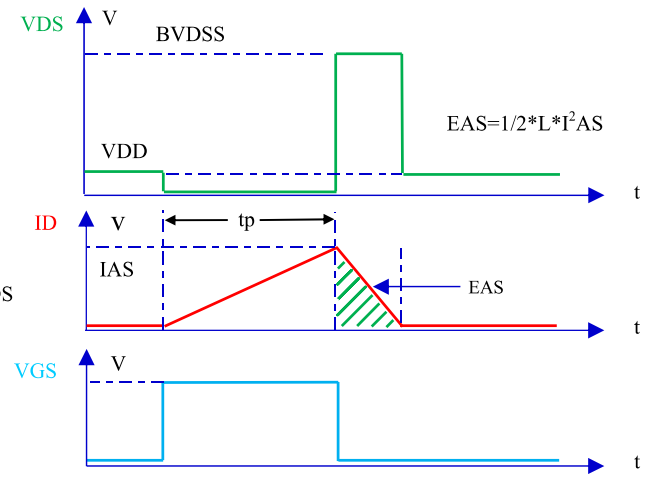
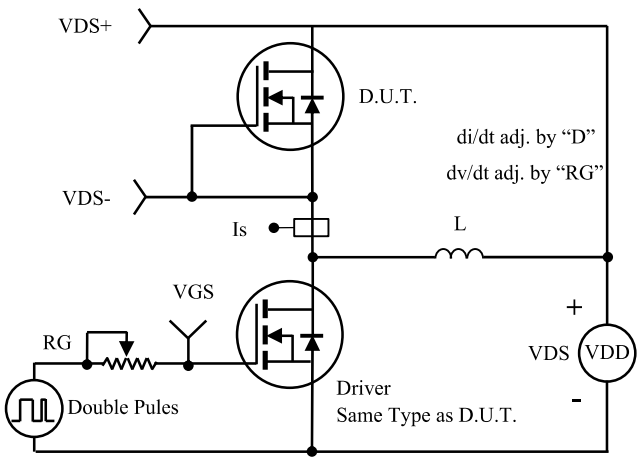


Fig.22- Unclamped Inductive Switching (UIS) Test Circuit & Waveform



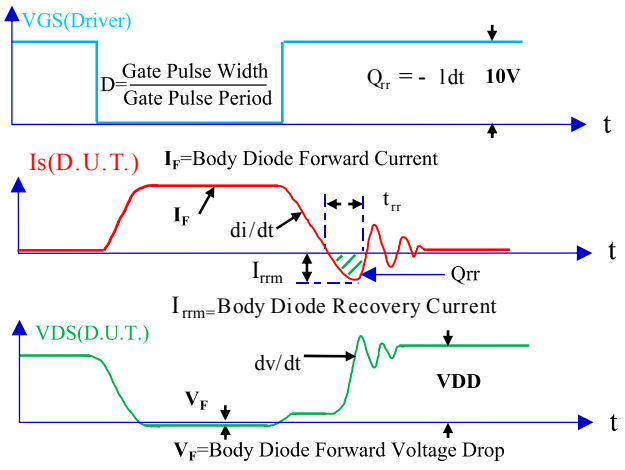


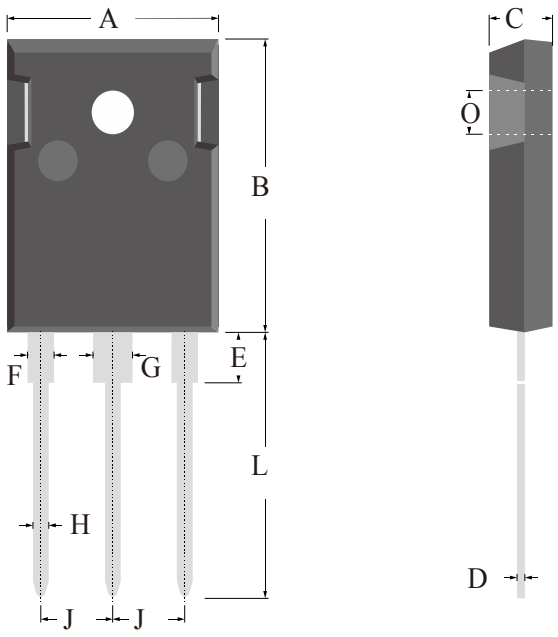
Fig.23- Diode Recovery Test Circuit & Waveform

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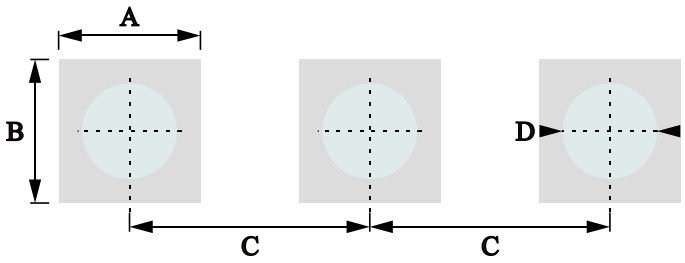
OUTLINE DRAWINGS



NCH75R130PT

OUTLINE DIMENSIONS						
Dim.	Milimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	15.25	-	16.75	0.6004	-	0.6594
B	20.50	-	22.50	0.8071	-	0.8858
C	4.50	-	5.10	0.1772	-	0.2008
D	0.40	-	0.80	0.0157	-	0.0315
E	3.40	-	5.00	0.1339	-	0.1969
F	1.80	-	2.50	0.0709	-	0.0984
G	2.70	-	3.30	0.1063	-	0.1299
H	1.00	-	1.40	0.0394	-	0.0551
J	5.15	-	5.75	0.2028	-	0.2264
L	18.50	-	20.50	0.7283	-	0.8071
O	2.85	-	3.15	0.1122	-	0.1240

RECOMMEDNED LAYOUT DRAWINGS



NCH75R130PT

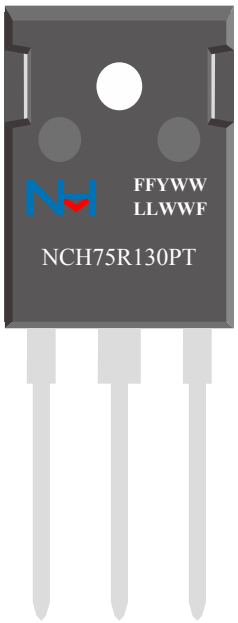
OUTLINE DIMENSIONS						
Dim.	Milimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	-	2.00	-	-	0.0787	-
B	-	2.00	-	-	0.0787	-
C	-	5.50	-	-	0.2165	-
D	-	1.40	-	-	0.0551	-

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N-Channel Silicon Carbide MOSFET

Pb-Free RoHS COMPLIANT

MARKING



MARKING INSTRUCTION

NH=Niuhang Trademark

FF=Product Line Code,According To Actual Changes

YWW=Date Code,According To Actual Changes

LLWWF=Inernal Code,According To Actual Changes

NCH75R130PT=Model

PACKING INFORMATION

Package Type	Package Code	Productor Weight Approx(g/Pcs)	Package Method	Quantity (Pcs/Min. Pack.)	Quantity (Pcs/Inner Box)	Quantity (Pcs/Carton)
TO-247	P1	5.778	Tube	30	600	2400

NCH75R130PT

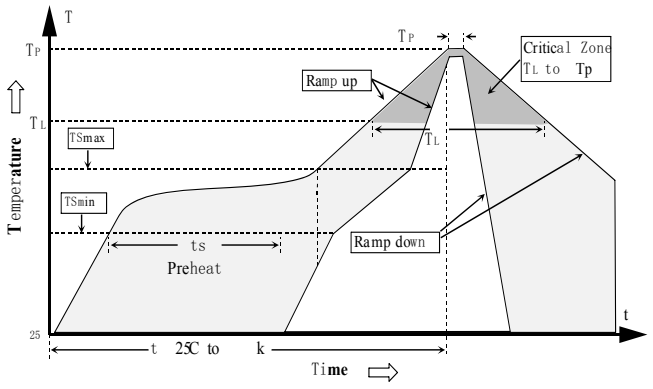
N-Channel Silicon Carbide MOSFET

Pb Pb-Free RoHS COMPLIANT

Recommended wave soldering condition

Product	Peak Temperature	Soldering Time
Pb-free devices	260 +0/-5 °C	5 +1/-1 seconds

Recommended temperature profile for IR reflow



Profile feature	Sn-Pb eutectic Assembly	Pb-free Assembly
Average ramp-up rate (Tsmax to Tp)	3°C/second max.	3°C/second max.
Preheat−Temperature Min (TS min) −Temperature Max (TS max) −Time(ts min to ts max)	100°C 150°C 60-120 seconds	150°C 200°C 60-180 seconds
Time maintained above: −Temperature (TL) − Time (tL)	183°C 60-150 seconds	217°C 60-150 seconds
Peak Temperature(TP)	240 +0/-5 °C	260 +0/-5 °C
Time within 5°C of actual peak temperature (tp)	10-30 seconds	20-40 seconds
Ramp down rate	6°C/second max.	6°C/second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

Note : All temperatures refer to topside of the package, measured on the package body surface.

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NCH75R130PT

N-Channel Silicon Carbide MOSFET

Pb-Free RoHS COMPLIANT

Specification Revision History

Rev.	Date	Changed Items	Pre-Changed Content	Changed Content
A/1	2025-10-20	First Issue		

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